

Abstract² 7HFKQRORJ\ KDV TXLFNO\ SURJUHVVHG ZLWK WKH DLG RI WKH FRQWLQDWLRQ RI ORRUH\ V ODZ ZKLFK VWDWHV D GRXEOLQJ RI WUDQVLVWRU GHQVLW\ HYHU\ WZR \HDUV +RZHYHU WKH FRPSOHPHQWLQJ SULQFLSOH RI ORRUH\ /DZ WKH 'HQKDUG 6FDOLQJ ZKLFK VWDWHV WKDW SRZHU GHQVLW\ ZRXOG VWD\ FRQVWDQW DV WUDQVLVWRU VL]HV VKUXQN VWRSSHG EHLQJ WUXH LQ :LWK WKH EUHDNLQJ GRZQ RI 'HQKDUG 6FDOLQJ QHZ FKDOOHQJHV ZHUh LQWURGXFHG LQFOXGLQJ LQ SRZHU PDQDJHPHQW DQG KHDW GLVVLSDWLRQ SDUWLFXODUO\ IRU VPDOOHU GHYLFHV OLNH HPEHGGHG V\VWHPV 7KLV XVKHUHG LQ D VHDUFK IRU LQQRYDWLYH VROXWLRQV HYHQWXDOO\ OHDGLQJ WR KHWHURJHQHRXV GHVLJQ ZKUH YDULRXV SURFHVVLQJ XQLWV OLNH &38V *38V DQG)3*\$V DUH LQWHJUDWHG LQWR D VLQJOH GHYLFH :LWK WKH LQWURGXFWLRQ DQG DGYDQFHPHQW RI KHWHURJHQHRXV V\VWHPV QHZ FDSDLOLWLHV DUH EHFRPLQJ SRVVLEOH ZLWKLQ VPDOO EXW IDVW DQG HQHUV\ HIILFLHQW GHYLFHV +RZHYHU ZLWK WKH KLJK FRPSOH[LW\ RI WKH V\VWHPV DQG ZLWK WKH SRZHU DQG KHDW GLVVLSDWLQJ FRQVWUDLQWV PXOWLSOH FKDOOHQJHV DUH LQYROYHG ,W LV YLWDO WR KHOS DGYDQFH KHWHURJHQHRXV HPEHGGHG V\VWHPV VLQFH LW LV VXFK YHUVDWLOH WHFKQRORJ\ DGYDQFLQJ KHWHURJHQHRXV V\VWHPV FDQ KHOS SURSHO YDULRXV VHFWRU

Keywords: component; heterogeneity; embedded systems; internet of things (IoT); power constraints; heat dissipation

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